IRLML2402PbF

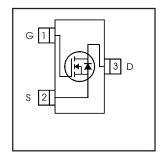
- Generation V Technology
- Ultra Low On-Resistance
- N-Channel MOSFET
- SOT-23 Footprint
- Low Profile (<1.1mm)
- Available in Tape and Reel
- Fast Switching
- Lead-Free
- RoHS Compliant, Halogen-Free

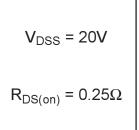
Description

Fifth Generation HEXFETs from International Rectifier utilize advanced processing techniques to achieve extremely low on-resistance per silicon area. This benefit, combined with the fast switching speed and ruggedized device design that HEXFET Power MOSFETs are well known for, provides the designer with an extremely efficient and reliable device for use in a wide variety of applications.

A customized leadframe has been incorporated into the standard SOT-23 package to produce a HEXFET Power MOSFET with the industry's smallest footprint. This package, dubbed the Micro3, is ideal for applications where printed circuit board space is at a premium. The low profile (<1.1mm) of the Micro3 allows it to fit easily into extremely thin application environments such as portable electronics and PCMCIA cards.









Page Part Number	Dookege Type	Standard Pa	ck	Oude vehic Peut Nomber	
Base Part Number	Package Type	Form Quantity		Orderable Part Number	
IRLML2402TRPbF	Micro3™ (SOT-23)	Tape and Reel	3000	IRLML2402TRPbF	

Absolute Maximum Ratings

	Parameter	Max.	Units
I _D @ T _A = 25°C	Continuous Drain Current, V _{GS} @ 4.5V	1.2	
I _D @ T _A = 70°C	Continuous Drain Current, V _{GS} @ 4.5V	0.95	Α
I _{DM}	Pulsed Drain Current ①	7.4	
P _D @T _A = 25°C	Power Dissipation	540	mW
	Linear Derating Factor	4.3	mW/°C
V _{GS}	Gate-to-Source Voltage	± 12	V
dv/dt	Peak Diode Recovery dv/dt ②	5.0	V/ns
$T_{J,}T_{STG}$	Junction and Storage Temperature Range	-55 to + 150	°C

Thermal Resistance

	Parameter	Тур.	Max.	Units
$R_{\theta JA}$	Maximum Junction-to-Ambient ④		230	°C/W



Electrical Characteristics @ T_J = 25°C (unless otherwise specified)

	Parameter	Min.	Тур.	Max.	Units	Conditions
V _{(BR)DSS}	Drain-to-Source Breakdown Voltage	20			V	V _{GS} = 0V, I _D = 250μA
$\Delta V_{(BR)DSS}/\Delta T_J$	Breakdown Voltage Temp. Coefficient		0.024		V/°C	Reference to 25°C, I _D = 1mA
Б				0.25		V _{GS} = 4.5V, I _D = 0.93A ③
R _{DS(on)}	Static Drain-to-Source On-Resistance			0.35	Ω	V _{GS} = 2.7V, I _D = 0.47A ③
V _{GS(th)}	Gate Threshold Voltage	0.70			V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$
g fs	Forward Transconductance	1.3			S	V _{DS} = 10V, I _D = 0.47A
I _{DSS}	Drain-to-Source Leakage Current			1.0		V _{DS} = 16V, V _{GS} = 0V
טיטוי	Brain-to-obtroe Leakage Garrent			25	μA	V _{DS} = 16V, V _{GS} = 0V, T _J = 125°C
lana	Gate-to-Source Forward Leakage			-100	nA	V _{GS} = -12V
I _{GSS}	Gate-to-Source Reverse Leakage			100	''^	V _{GS} = 12V
Qg	Total Gate Charge		2.6	3.9		I _D = 0.93A
Q _{gs}	Gate-to-Source Charge		0.41	0.62	nC	V _{DS} = 16V
Q _{gd}	Gate-to-Drain ("Miller") Charge		1.1	1.7		V _{GS} = 4.5V, See Fig. 6 and 9 ③
t _{d(on)}	Turn-On Delay Time		2.5			V _{DD} = 10V
t _r	Rise Time		9.5			$I_D = 0.93A$
t _{d(off)}	Turn-Off Delay Time		9.7		ns ·	$R_G = 6.2\Omega$
t _f	Fall Time		4.8			R_D = 11 Ω , See Fig. 10 ③
C _{iss}	Input Capacitance		110			V _{GS} = 0V
C _{oss}	Output Capacitance		51		pF	V _{DS} = 15V
C _{rss}	Reverse Transfer Capacitance		25			f = 1.0MHz, See Fig. 5

Source-Drain Ratings and Characteristics

	Parameter	Min.	Тур.	Max.	Units	Conditions
Is	Continuous Source Current			0.54		MOSFET symbol
	(Body Diode)			0.54	$\begin{bmatrix} A \end{bmatrix}$	showing the
I _{SM}	Pulsed Source Current			7.4	「	integral reverse
	(Body Diode) ①			7.4		p-n junction diode.
V _{SD}	Diode Forward Voltage			1.2	V	$T_J = 25$ °C, $I_S = 0.93$ A, $V_{GS} = 0$ V ③
t _{rr}	Reverse Recovery Time		25	38	ns	$T_J = 25$ °C, $I_F = 0.93A$
Q _{rr}	Reverse RecoveryCharge		16	24	nC	di/dt = 100A/µs ③

Notes:

- ① Repetitive rating; pulse width limited by max. junction temperature. (See fig. 11)
- $\begin{tabular}{ll} @ I_{SD} \le 0.93A, & di/dt \le 90A/\mu s, & V_{DD} \le V_{(BR)DSS}, \\ & T_J \le 150 ^{\circ}C \end{tabular}$
- 4 Surface mounted on FR-4 board, $t \leq 5sec.$



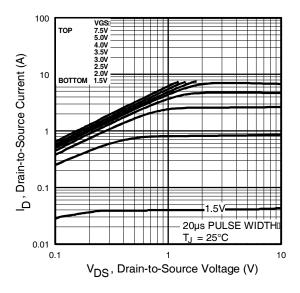


Fig 1. Typical Output Characteristics

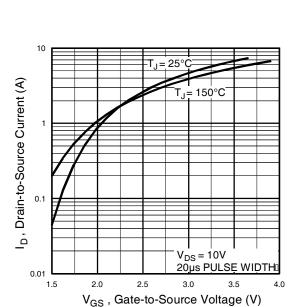


Fig 3. Typical Transfer Characteristics

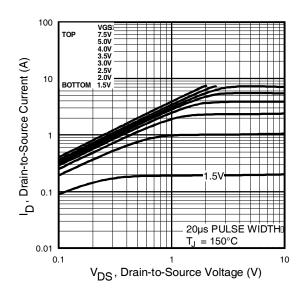


Fig 2. Typical Output Characteristics

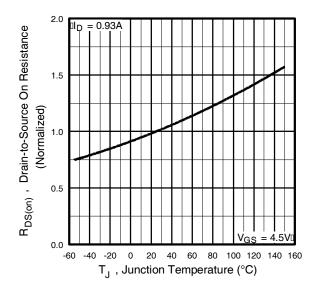


Fig 4. Normalized On-Resistance Vs. Temperature



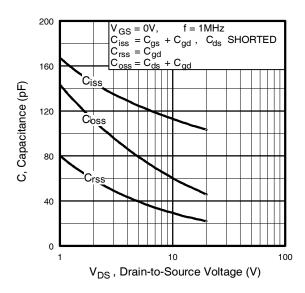


Fig 5. Typical Capacitance Vs. Drain-to-Source Voltage

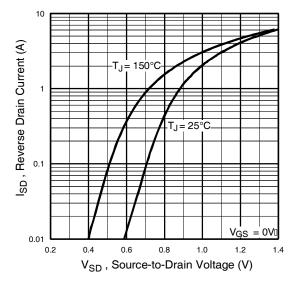


Fig 7. Typical Source-Drain Diode Forward Voltage

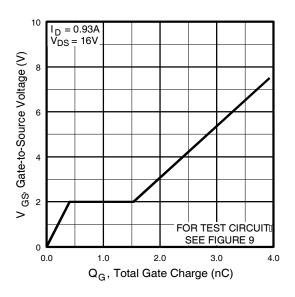


Fig 6. Typical Gate Charge Vs. Gate-to-Source Voltage

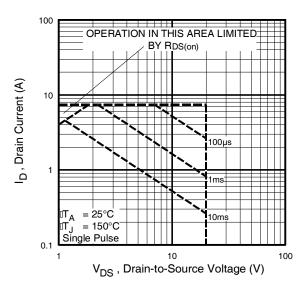


Fig 8. Maximum Safe Operating Area



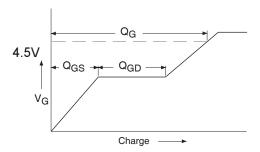


Fig 9a. Basic Gate Charge Waveform

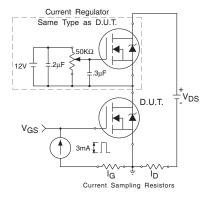


Fig 9b. Gate Charge Test Circuit

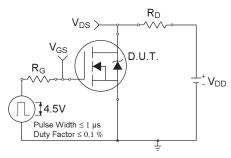


Fig 10a. Switching Time Test Circuit

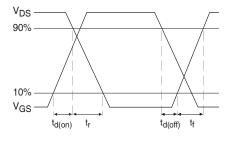


Fig 10b. Switching Time Waveforms

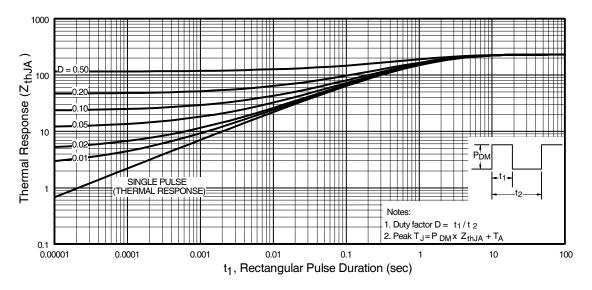
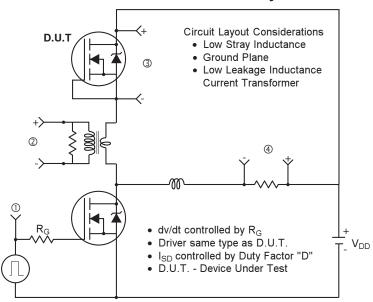


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Ambient



Peak Diode Recovery dv/dt Test Circuit



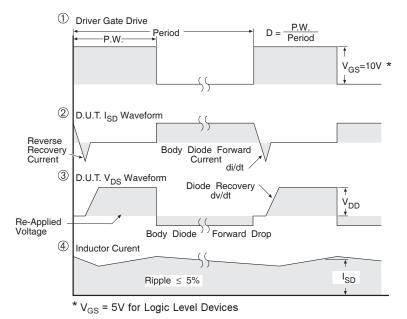
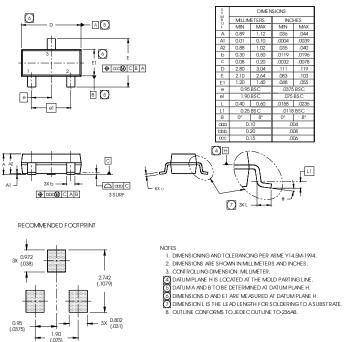


Fig 12. For N-Channel HEXFETS



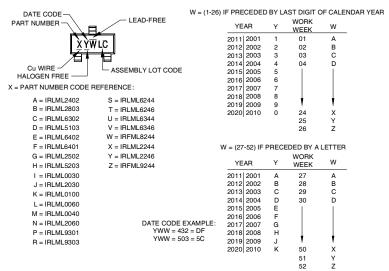
Micro3 (SOT-23) (Lead-Free) Package Outline

Dimensions are shown in millimeters (inches)



Micro3 (SOT-23 / TO-236AB) Part Marking Information

Notes: This part marking information applies to devices produced after 02/26/2001

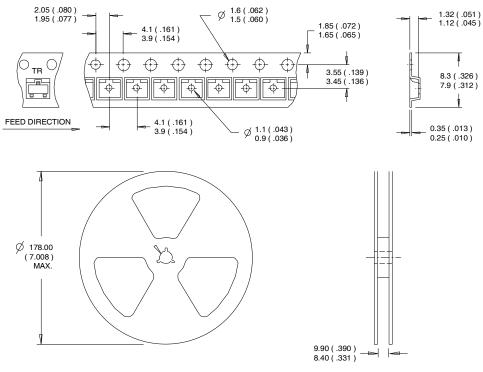


Note: For the most current drawing please refer to IR website at http://www.irf.com/package



Micro3™ Tape & Reel Information

Dimensions are shown in millimeters (inches)



NOTES:

- CONTROLLING DIMENSION : MILLIMETER.
 OUTLINE CONFORMS TO EIA-481 & EIA-541.

Note: For the most current drawing please refer to IR website at http://www.irf.com/package



RoHS compliant

Qualification information						
	Consumer					
Qualification level	(per JEDEC JESD47F ^{††} guidelines)					
Moisture Sensitivity Level	Micro3 [™] (SOT-23)	MSL1				

- † Qualification standards can be found at International Rectifier's web site: http://www.irf.com/product-info/reliability
- †† Applicable version of JEDEC standard at the time of product release

Revision History

Date	Comment			
	Updated data sheet with new IR corporate template.			
4/24/2014	Updated package outline & part marking on page 7.			
4/24/2014	Added Qualification table -Qual level "Consumer" on page 9.			
	Added bullet point in the Benefits "RoHS Compliant, Halogen -Free" on page 1.			



IR WORLD HEADQUARTERS: 101 N. Sepulveda Blvd., El Segundo, California 90245, USA To contact International Rectifier, please visit http://www.irf.com/whoto-call/

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

International Rectifier:

IRLML2402TRPBF